

RX Family

QSPIX Module Using Firmware Integration Technology

Introduction

This document covers the QSPIX Module Using Firmware Integration Technology (FIT) for the supported RX family MCUs. Details are provided that describe the QSPIX driver's architecture, integration of the FIT module into a user's application, and how to use the API.

The RX family MCUs supported by this module have a built-in Quad Serial Peripheral Interface (QSPIX) for only one channel. The Quad-SPI Memory Interface (QSPIX) module is a memory controller for connecting serial ROM that has an SPI compatible interface. This includes nonvolatile memory, such as a serial flash memory, serial EEPROM, or serial FeRAM.

Target Device

The following is a list of devices that are currently supported by this API:

- RX671 Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to "6.1 Operation Confirmation Environment".

Related Documents

- Firmware Integration Technology User's Manual (R01AN1833)
- RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)

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1. Overview

The QSPIX FIT module can be combined with other FIT modules for easy integration into the target system.

The functions of the QSPIX FIT module can be incorporated into software programs by means of APIs.

It is recommended to review the QSPIX peripheral chapter in the RX MCU hardware user's manual before using this software.

1.1 QSPIX FIT Module

The QSPIX FIT module can be used by being implemented in a project as an API. See section 2.13, Adding the FIT Module to Your Project for details on methods to implement this FIT module into a project.

1.2 Overview of the QSPIX FIT Module

After adding the QSPIX FIT module to your project you will need to modify the `r_qspix_rx_config.h` file to configure the software for your installation. See Section 2.8 Configuration Overview for details on configuration options.

The QSPIX FIT module does not have a function to initialize a register of the I/O port. The setting of the I/O port must be accomplished other than this module. See Section 4, Pin Setting for setting of the I/O port.

The functions of the module are described briefly below.

Table 1-1 QSPIX Specifications

Parameter	Specifications
Number of channels	1 channel
SPI	<ul style="list-style-type: none">• Support for Extended SPI, Dual SPI, and Quad SPI protocols• Configurable to SPI mode 0 and SPI mode 3• Address width selectable to 8, 16, 24, or 32 bits
Timing adjustment function	Configurable to support a wide range of serial flash
Memory mapped mode	<ul style="list-style-type: none">• Support for Read, Fast Read, Fast Read Dual Output, Fast Read Dual I/O, Fast Read Quad Output, and Fast Read Quad I/O instructions• Substitutable instruction code• Adjustable number of dummy cycles• Prefetch function• Polling processing• SPI bus cycle extension function
Indirect access mode	Flexible support for a wide variety of serial flash instructions and functions through software control, including erase, write, ID read, and power-down control
Interrupt source	Error interrupts

1.3 Using the FIT QSPIX module

Using FIT QSPIX module in C++ project

For C++ project, add FIT QSPIX module interface header file within extern "C":

```
Extern "C"
{
    #include "r_smc_entry.h"
    #include "r_qspix_rx_if.h"
}
```

1.4 API Overview

Table 1-2 API Functions lists the API functions included in this module. Also, section 2.9, Code Size, lists the size of the code sections used by this module.

Table 1-2 API Functions

Function	Function Description
R_QSPIX_Open()	This function applies power to the QSPIX channel, initializes the associated registers, enables interrupts, and provides the channel handle for use with other API functions.
R_QSPIX_Control()	This function is used to change settings.
R_QSPIX_Write_Indirect()	Writes raw data directly to the QSPIX.
R_QSPIX_Read_Indirect()	Reads raw data directly from the QSPIX. This API can only be called after R_QSPIX_Write_indirect() with read_after_write set to true.
R_QSPIX_Enter_XIP()	Enters XIP(execute in place) mode.
R_QSPIX_Exit_XIP()	Exits XIP(execute in place) mode.
R_QSPIX_BankSet()	Selects the bank to access.
R_QSPIX_Set_Spi_Protocol()	Selects the protocol to access.
R_QSPIX_Get_Status()	Get status of Prefetch, busy flag, ROM access error flag.
R_QSPIX_Closes()	Close the QSPIX driver module.
R_QSPIX_GetVersion()	This function returns the version number of the API.

1.5 Hardware Settings

1.5.1 Hardware Configuration Example

Figure 1-1 is a connection diagram. To achieve high-speed operation, consider adding damping resistors or capacitors to improve the circuit matching of the various signal lines.

Do not fail to perform pull-up processing. Without pull-up processing, the slave device may enter the write protect state or hold state when a data line is in the Hi-Z state.

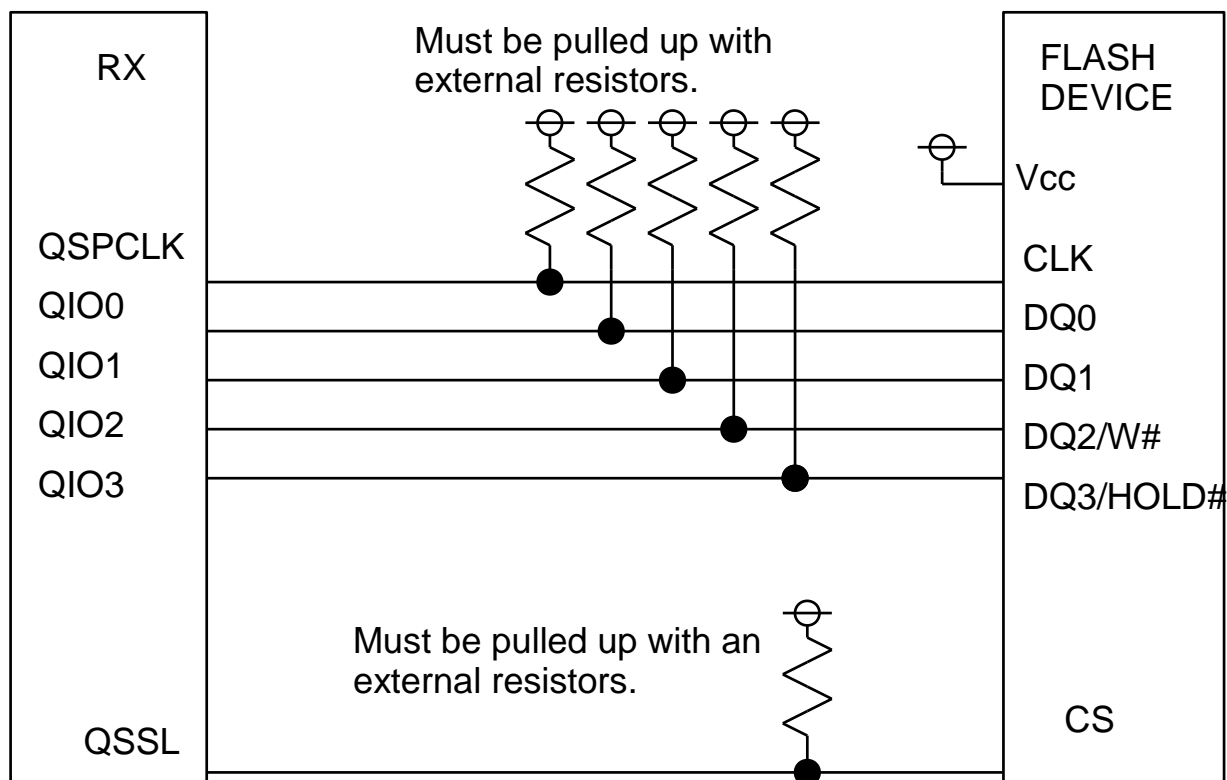


Figure 1.1 : Sample Wiring Diagram for a RX Family MCU QSPI and a Flash Device

1.5.2 List of Pins

Table 1-3 lists the pins that are used and their uses.

Pin Name	I/O	Description
QSPCLK	Output	QSPIX clock output pin
QSSL	Output	QSPIX slave select pin
QIO0	I/O	Data 0 input/output
QIO1	I/O	Data 1 input/output
QIO2	I/O	Data 2 input/output
QIO3	I/O	Data 3 input/output

2. API Information

This Driver API follows the Renesas API naming standards.

2.1 Hardware Requirements

The microcontroller used must support the following functionality.

- QSPIX

2.2 Software Requirements

This driver is dependent on the following packages.

- Renesas Board Support Package (r_bsp) v6.10 or higher

2.3 Limitations

2.3.1 RAM Location Limitations

In FIT, if a value equivalent to NULL is set as the pointer argument of an API function, error might be returned due to parameter check. Therefore, do not pass a NULL equivalent value as pointer argument to an API function.

The NULL value is defined as 0 because of the library function specifications. Therefore, the above phenomenon would occur when the variable or function passed to the API function pointer argument is located at the start address of RAM (address 0x0). In this case, change the section settings or prepare a dummy variable at the top of the RAM so that the variable or function passed to the API function pointer argument is not located at address 0x0.

In the case of the CCRX project (e2 studio V21.1.0), the RAM start address is set as 0x4 to prevent the variable from being located at address 0x0. In the case of the GCC project (e2 studio V21.1.0) and IAR project (EWRX V4.20.1), the start address of RAM is 0x0, so the above measures are necessary.

The default settings of the section may be changed due to the IDE version upgrade. Please check the section settings when using the latest IDE.

2.4 Supported Toolchain

The operation of QSPIX FIT module has been confirmed with the toolchain listed in “6.1 Operation Confirmation Environment”.

2.5 Interrupt Vector

The QSPIX (ROM access error) is enabled by executing the R_QSPIX_Open function (while the macro definition QSPIX_CFG_ERI_INCLUDED is 1).

Table 2.1 lists the interrupt vectors used in the FIT Module.

Table 2-1 Interrupt Vector

Device	Interrupt Vector
RX671	GROUPAL0 interrupt (vector no.: 30)

2.6 Header Files

All the API calls and interface definitions used are listed in r_qspix_rx_if.h.
Configuration options for individual builds are selected in r_qspix_rx_config.h.

2.7 Integer Types

This project uses ANSI C99. These types are defined in stdint.h.

2.8 Configuration Overview

The configuration option settings of this module are located in `r_qspix_rx_config.h`. The option names and setting values are listed in the table below:

Configuration options in <code>r_qspix_rx_config.h</code>	
Definition	Description
QSPIX_CFG_PARAM_CHECKING_ENABLE (1)	1: Parameter checking is included in the build. 0: Parameter checking is omitted from the build.
QSPIX_CFG_USE_CH0 (1)	Enable the QSPIX channels. (0) = not used. (1) = used.
QSPIX_CFG_ERI_INCLUDED (1)	1: ROM access error is included in the build. 0: ROM access error is omitted in the build.
QSPIX_CFG_ERI_IR_PRIORITY (3)	Sets the ROM access error interrupt priority for the channel. The value selected by a value from 1 to 15 is set as the interrupt level.

2.9 Code Size

The sizes of ROM, RAM, and maximum stack usage associated with this module are listed below.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.8 Configuration Overview

The values in the table below are confirmed under the following conditions.

Module Revision: `r_qspix_rx` rev1.00

Compiler Version: Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00

(The option of “-lang = c99” is added to the default settings of the integrated development environment.)

GCC for Renesas RX 8.3.0.202004

(The option of “-std = gnu99” is added to the default settings of the integrated development environment.)

IAR C/C++ Compiler for Renesas RX version 4.20.3

(The default settings of the integrated development environment)

Configuration Options: Default settings

ROM, RAM and Stack Code Sizes							
Device	Category	Memory Used					
		Renesas Compiler		GCC		IAR Compiler	
		With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking
RX671	ROM	1609 bytes	1291 bytes	3360 bytes	2944 bytes	2857 bytes	2378 bytes
	RAM	72 bytes		72 bytes		4 bytes	
	STACK	16 bytes		-		100 bytes	

2.10 Arguments

The structure for the arguments of the API functions is shown below. This structure is listed in

r_qspix_rx_if.h, along with the prototype declarations of the API functions.

```
typedef struct st_qspix_cfg
{
    /* Read Instruction Select */
    qspix_read_mode_t                read_mode;

    /* Slave Select Extension */
    qspix_slave_select_extension_t    slave_select_extension;

    /* Slave Select Extension */
    qspix_prefetch_function_t         prefetch_function;

    /* Clock Mode Select */
    qspix_clock_mode_t               clock_mode;

    /* Data Output Duration Extension */
    qspix_data_output_select_t        data_output_select;

    /* Special Read Instruction Select */
    qspix_special_instruction_select_t special_instruction_select;

    /* Slave Select High Width Setting */
    qspix_slave_select_high_width_t    slave_select_high_width;

    /* Slave Select Hold Time Setting */
    qspix_slave_select_hold_time_t      slave_select_hold_time;

    /* Slave Select Setup Time Setting */
    qspix_slave_select_setup_time_t     slave_select_setup_time;

    /* Clock Divisor Select */
    qspix_clock_divisor_t              clock_divisor;

    /* Special Read Instruction Setting used when
       special_instruction_select = QSPIX_INSTRUCTION_CODE_IN_SPRIR_REGISTER */
    uint32_t qspix_special_read_instruction;

    /* Address Size Setting */
    qspix_address_size_t              address_size;

    /* Instruction with 4-Byte Address Enable */
    qspix_instruction_4_Byte_address_t instruction_4_Byte_address;

    /* Number of Dummy Cycle */
    qspix_dummy_clocks_t              dummy_clocks;

    /* SPI protocol */
    qspix_protocol_t                  protocol;

    /* WP Pin Control */
    qspix_WP_pin_control_t            WP_pin_control;

    void (*p_callback)(void *p_cbdat); /* pointer to user callback function. */
} qspix_cfg_t;
```

2.11 Return Values

The API function return values are shown below. This enumerated type is listed in `r_qspix_rx_if.h`, along with the prototype declarations of the API functions.

```
typedef enum e_qspix_err          /* QSPIX API error codes */
{
    QSPIX_SUCCESS,                /* QSPIX processing completed without problem. */
    QSPIX_ERR_OPENED,             /* QSPIX was initialized already. */
    QSPIX_ERR_NOT_OPEN,           /* QSPIX module is not initialized yet. */
    QSPIX_ERR_INVALID_ARG,        /* Arguments are invalid. */
    QSPIX_ERR_INVALID_COMMAND,    /* Command parameters are invalid. Or, forced
data change failed. */
    QSPIX_ERR_NULL_PTR,           /* Argument pointers are NULL. */
    QSPIX_ERR_BUSY,               /* The QSPIX resources are locked by another process. */
    QSPIX_ERR_HW                  /* HW error. */
} qspix_err_t;
```

2.12 Callback Functions

In this module, the callback function specified by the user is called when the ROM access error interrupt occurs.

The callback function is specified by storing the address of the user function in the “void (*p_callback)(void *p_cbdat)” structure member (see 2.10, Arguments).

2.13 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (3) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) or (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e² studio
By using the Smart Configurator in e² studio, the FIT module is automatically added to your project. Refer to “Renesas e² studio Smart Configurator User Guide (R20AN0451)” for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e² studio
By using the FIT Configurator in e² studio, the FIT module is automatically added to your project. Refer to “Adding Firmware Integration Technology Modules to Projects (R01AN1723)” for details.
- (3) Adding the FIT module to your project using the Smart Configurator in CS+
By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to “Renesas e² studio Smart Configurator User Guide (R20AN0451)” for details.
- (4) Adding the FIT module to your project in CS+
In CS+, please manually add the FIT module to your project. Refer to “Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)” for details.

3. API Functions

R_QSPIX_Open()

This function applies power to the QSPIX channel, initializes the associated registers, enables interrupts, and provides the channel handle for use with other API functions.

Format

```
qspix_err_t R_QSPIX_Open (uint8_t channel, qspix_cfg_t * p_cfg)
```

Parameters

channel

Number of the QSPIX channel to be initialized.

**p_cfg*

Pointer to QSPIX channel configuration data structure.

Return Values

QSPIX_SUCCESS	/* QSPIX processing completed without problem. */
QSPIX_ERR_OPENED	/* QSPIX was initialized already. */
QSPIX_ERR_INVALID_ARG	/* Arguments are invalid. */
QSPIX_ERR_NULL_PTR	/* Argument pointers are NULL. */
QSPIX_ERR_BUSY	/* The QSPIX resources are locked by another process. */

Properties

The declaration is located in `r_qspix_rx_if.h`.

Description

The Open function is responsible for preparing an QSPIX channel for operation. This function must be called once prior to calling any other QSPIX API functions (except `R_QSPIX_GetVersion`). Once successfully completed, the status of the selected channel QSPIX will be set to "open". After that, this function should not be called again for the same QSPIX channel without first performing a "close" by calling `R_QSPIX_Close()`. Communication is not yet available upon completion of this processing.

After the driver is open, the QSPIX can be accessed like internal flash memory starting at address 0x70000000.

Example

Condition: Channel not yet open

```
void rom_error_access(void *p_cbdat);
void rom_error_access(void *p_cbdat)
{
    /* Code for handle ROM error access */

    R_BSP_NOP();
}
qspix_err_t ret = QSPIX_SUCCESS;
qspix_cfg_t p_cfg;
/* Set read mode */
p_cfg.read_mode = QSPIX_READ_MODE_STANDARD;

/* Set Slave Select Extension */
p_cfg.slave_select_extension = QSPIX_DO_NOT_EXTEND_QSSL;

/* Set Prefetch Function Enable */
p_cfg.prefetch_function = QSPIX_PREFETCH_ENABLE;

/* Set Clock Mode */
p_cfg.clock_mode = QSPIX_SPI_MODE_0;
```

```
/* Set Data Output Duration Extension */
p_cfg.data_output_select = QSPIX_DO_NOT_EXTEND;

/* Set Special Read Instruction Select */
p_cfg.special_instruction_select=QSPIX_DEFAULT_INSTRUCTION_CODE;

/* Set Slave Select High Width Setting */
p_cfg.slave_select_high_width=QSPIX_1_CYCLE_QSPCLK;

/* Set Slave Select Hold Time Setting */
p_cfg.slave_select_hold_time=QSPIX_RELEASE_QSSL_0_5_QSPCLK;

/* Set Slave Select Setup Time Setting */
p_cfg.slave_select_setup_time=QSPIX_OUTPUT_QSSL_0_5_QSPCLK;

/* Set Clock Divisor Select */
p_cfg.clock_divisor=QSPIX_ICLK_DIV_2;

/* Set Address Size */
p_cfg.address_size=QSPIX_3_BYTES;

/* Set Instruction with 4-Byte Address Enable */
p_cfg.instruction_4_Byte_address=QSPIX_INSTRUCTION_4_BYTE_ADDRESS_DISABLE;

/* Set Number of Dummy Cycle */
p_cfg.dummy_clocks=QSPIX_DEFAULT_DUMMY_CYCLES;

/* Set SPI protocol */
p_cfg.protocol=QSPIX_EXTENDED_SPI_PROTOCOL;

/* Set WP Pin Control */
p_cfg.WP_pin_control=QSPIX_LOW_LEVEL;

/* Set callback function */
p_cfg.p_callback = rom_error_access;

/* Call R_QSPIX_Open */
ret = R_QSPIX_Open(QSPIX_CH0,&p_cfg);

/* If there were an error this would demonstrate error detection of API
calls. */
if (QSPIX_SUCCESS != ret)
{
    return error(); // Your error handling code would go here.
}

/* Initialize I/O port pins for use with the QSPIX peripheral.
 * This is specific to the MCU and ports chosen. */
R_QSPIX_PinSet_QSPIX0();
```

R_QSPIX_Control()

This function is used to change settings.

Format

```
qspi_err_t R_QSPIX_Control(uint8_t channel, qspi_cfg_t *p_cfg);
```

Parameters

channel

Number of the QSPIX channel to be control.

**p_cfg*

Pointer to QSPIX channel configuration data structure.

Return Values

QSPIX_SUCCESS	/* QSPIX processing completed without problem. */
QSPIX_ERR_NOT_OPEN	/* QSPIX module is not initialized yet. */
QSPIX_ERR_INVALID_ARG	/* Arguments are invalid. */
QSPIX_ERR_NULL_PTR	/* Argument pointers are NULL. */

Properties

The declaration is located in `r_qspi_rx_if.h`.

Description

This function modify the operating of QSPIX channel for a particular mode. This function must be called after `R_QSPIX_Open`.

Example

```
void rom_error_access(void *p_cbdat);
void rom_error_access(void *p_cbdat)
{
    /* Code for handle ROM error access */

    R_BSP_NOP();
}
qspi_err_t ret = QSPIX_SUCCESS;
qspi_cfg_t p_cfg;

/* Set read mode */
p_cfg.read_mode = QSPIX_READ_MODE_STANDARD;

/* Set Slave Select Extension */
p_cfg.slave_select_extension = QSPIX_DO_NOT_EXTEND_QSSL;

/* Set Prefetch Function Enable */
p_cfg.prefetch_function = QSPIX_PREFETCH_ENABLE;

/* Change Clock Mode */
p_cfg.clock_mode = QSPIX_SPI_MODE_3;

/* Set Data Output Duration Extension */
p_cfg.data_output_select = QSPIX_DO_NOT_EXTEND;

/* Set Special Read Instruction Select */
p_cfg.special_instruction_select=QSPIX_DEFAULT_INSTRUCTION_CODE;

/* Set Slave Select High Width Setting */
```

```
p_cfg.slave_select_high_width=QSPIX_1_CYCLE_QSPCLK;

/* Set Slave Select Hold Time Setting */
p_cfg.slave_select_hold_time=QSPIX_RELEASE_QSSL_0_5_QSPCLK;

/* Set Slave Select Setup Time Setting */
p_cfg.slave_select_setup_time=QSPIX_OUTPUT_QSSL_0_5_QSPCLK;

/* Set Clock Divisor Select */
p_cfg.clock_divisor=QSPIX_ICLK_DIV_2;

/* Set Address Size */
p_cfg.address_size=QSPIX_3_BYTES;

/* Set Instruction with 4-Byte Address Enable */
p_cfg.instruction_4_Byte_address=QSPIX_INSTRUCTION_4_BYTE_ADDRESS_DISABLE;

/* Set Number of Dummy Cycle */
p_cfg.dummy_clocks=QSPIX_DEFAULT_DUMMY_CYCLES;

/* Set SPI protocol */
p_cfg.protocol=QSPIX_EXTENDED_SPI_PROTOCOL;

/* Set WP Pin Control */
p_cfg.WP_pin_control=QSPIX_LOW_LEVEL;

/* Set callback function */
p_cfg.p_callback = rom_error_access;

/* Call R_QSPIX_Control */
ret = R_QSPIX_Control(QSPIX_CH0,&p_cfg);

/* If there were an error this would demonstrate error detection of API
calls. */
if (QSPIX_SUCCESS != ret)
{
    return error(); // Your error handling code would go here.
}
```

R_QSPIX_Write_Indirect()

Writes raw data directly to the QSPIX.

Format

```
qspi_err_t R_QSPIX_Write_Indirect(uint8_t channel,
                                   uint8_t *p_src_addr,
                                   uint32_t bytes,
                                   bool read_after_write);
```

Parameters

channel

Channel of QSPIX use to write data.

**p_src_addr*

Pointer to data to write.

bytes

Number of bytes to write.

read_after_write

Whether or not to close SPI bus cycle.

Return Values

```
QSPIX_SUCCESS          /* Processing completed without problem */
QSPIX_ERR_NOT_OPEN     /* QSPIX module is not initialized yet */
QSPIX_ERR_INVALID_ARG  /* Invalid argument */
QSPIX_ERR_NULL_PTR     /* Argument pointers are NULL */
```

Properties

Prototyped in file "r_qspi_rx_if.h"

Description

Uses the QSPIX of the channel number specified by the argument channel to write data.

Number of bytes is depend on the Flash(maximum size of 1 page) is used.

When writing a large volume of data, communication is divided into page units.

Example

```
#define QSPIX_COMMAND_READ_MODE_STANDARD (0x03)
/* Conditions: Channel currently open. */
/* Pointer to store data */
uint8_t data[4];
/* Pointer to data to write */
uint8_t buffer [10];

data[0] = QSPIX_COMMAND_READ_MODE_STANDARD;
data[1] = 0x00; Input the higher-order byte at address 0x000000.
data[2] = 0x00; Input the middle byte at target address 0x000000.
data[3] = 0x00; Input the lower-order byte at target address 0x000000.

/* Send the standard 0x03 command followed by 3 address bytes */
R_QSPIX_Write_Indirect(QSPIX_CH0, &data[0],4,true);

/* Read 10 bytes from Flash */
R_QSPIX_Read_Indirect(QSPIX_CH0, &buffer[0],10);
```

Special Notes:

Only Extended SPI protocol is allowed to use in Indirect access mode, the standard Read or Fast Read instruction must be used to reference the contents of the serial flash. The QSPIX does not support Fast Read Dual Output, Fast Read Dual I/O, Fast Read Quad Output, or Fast Read Quad I/O transfers in this configuration. When these high-speed read operations are required, use ordinary flash access.

R_QSPIX_Read_Indirect()

Reads raw data directly from the QSPIX. This API can only be called after R_QSPIX_Write_Indirect() with read_after_write set to true.

Format

```
qspi_err_t R_QSPIX_Read_Indirect(uint8_t channel,
                                  uint8_t *p_des_addr,
                                  uint32_t bytes);
```

Parameters

channel

Channel of QSPIX use to read data.

**p_des_addr*

Pointer to store data.

bytes

Number of bytes to read.

Return Values

QSPIX_SUCCESS	/* Processing completed without problem */
QSPIX_ERR_NOT_OPEN	/* QSPIX module is not initialized yet */
QSPIX_ERR_INVALID_ARG	/* Invalid argument */
QSPIX_ERR_NULL_PTR	/* Argument pointers are NULL */

Properties

The declaration is located in r_qspi_rx_if.h.

Description

Uses the QSPIX of the channel number specified by the argument channel to read data. Number of bytes is depend on the Flash is used.

Example

```
#define QSPIX_COMMAND_READ_MODE_STANDARD (0x03)
/* Conditions: Channel currently open. */
/* Pointer to store data */
uint8_t data[4];
/* Pointer to data to write */
uint8_t buffer [10];

data[0] = QSPIX_COMMAND_READ_MODE_STANDARD;
data[1] = 0x00; Input the higher-order byte at address 0x000000.
data[2] = 0x00; Input the middle byte at target address 0x000000.
data[3] = 0x00; Input the lower-order byte at target address 0x000000.

/* Send the standard 0x03 command followed by 3 address bytes */
R_QSPIX_Write_Indirect(QSPIX_CH0, &data[0],4,true);

/* Read 10 bytes from Flash */
R_QSPIX_Read_Indirect(QSPIX_CH0, &buffer[0],10);
```

Special Notes:

Only Extended SPI protocol is allowed to use in Indirect access mode, the standard Read or Fast Read instruction must be used to reference the contents of the serial flash. The QSPIX does not support Fast Read Dual Output, Fast Read Dual I/O, Fast Read Quad Output, or Fast Read Quad I/O transfers in this configuration. When these high-speed read operations are required, use ordinary flash access.

R_QSPIX_Enter_XIP()

Enters XIP(execute in place) mode.

Format

```
qspi_err_t R_QSPIX_Enter_XIP(uint8_t channel, uint8_t mode);
```

Parameters

channel

Channel of QSPIX Enters XIP (execute in place) mode.

mode

Enter XIP Mode.

Return Values

QSPIX_SUCCESS	/* Processing completed without problem */
QSPIX_ERR_NOT_OPEN	/* QSPIX module is not initialized yet */
QSPIX_ERR_HW	/* Hardware error */

Properties

Prototyped in file "r_qspi_rx_if.h"

Description

To select the XIP mode, specify the XIP mode configuration for the serial flash device in the MODE [7:0] bits in the SPDCCR register.

Example

```
/* Conditions: Channel currently open. */  
/* Enter XIP */  
R_QSPIX_Enter_XIP(QSPIX_CH0, 0xA5);
```

R_QSPIX_Exit_XIP()

Exits XIP(execute in place) mode.

Format

```
qspi_err_t R_QSPIX_Exit_XIP(uint8_t channel, uint8_t mode);
```

Parameters

channel

Channel of QSPIX Exits XIP (execute in place) mode

mode

Exit XIP Mode

Return Values

QSPIX_SUCCESS	/* Processing completed without problem */
QSPIX_ERR_NOT_OPEN	/* QSPIX module is not initialized yet */
QSPIX_ERR_HW	/* Hardware error */

Properties

Prototyped in file "r_qspi_rx_if.h"

Description

To select the XIP mode, specify the XIP mode configuration for the serial flash device in the MODE [7:0] bits in the SPDCR register.

Example

```
/* Conditions: Channel currently open. */
/* Exits XIP */
R_QSPIX_Exit_XIP(QSPIX_CH0, 0xFF);
```

R_QSPIX_BankSet()

Selects the bank to access.

Format

```
qspi_err_t R_QSPIX_BankSet(uint8_t channel, uint8_t bank);
```

Parameters

channel

Channel for switch bank.

bank

Bank need to set.

Return Values

```
QSPIX_SUCCESS           /* Processing completed without problem */
QSPIX_ERR_INVALID_ARG   /* Arguments are invalid */
QSPIX_ERR_NOT_OPEN      /* QSPIX module is not initialized yet */
```

Properties

Prototyped in file "r_qspi_rx_if.h"

Description

A bank is a 64MB sliding access window into the QSPI device flash memory space. To access chip address 0x4000000, select bank 1, then read from internal flash address 0x70000000. To access chip address 0x8001000, select bank 2, then read from internal flash address 0x70001000.

This function is not required for memory devices less than or equal to 512 Mb (64MB).

Example

```
/* Conditions: Channel currently open. */
/* Select bank 1*/
R_QSPIX_BankSet(QSPIX_CH0,1);
```

R_QSPIX_Set_Spi_Protocol()

Selects the protocol to access.

Format

```
qspi_err_t R_QSPIX_Set_Spi_Protocol(uint8_t channel,  
                                     qspi_protocol_t protocol);
```

Parameters

channel

Channel for set protocol.

protocol

Protocol need to set.

Return Values

```
QSPIX_SUCCESS          /* Processing completed without problem */  
QSPIX_ERR_INVALID_ARG  /* Arguments are invalid */  
QSPIX_ERR_NOT_OPEN     /* QSPIX module is not initialized yet */
```

Properties

Prototyped in file "r_qspi_rx_if.h"

Description**Example**

```
/* Conditions: Channel currently open. */  
/* Select protocol Quad SPI protocol */  
R_QSPIX_Set_Spi_Protocol(QSPIX_CH0, QSPIX_QUAD_SPI_PROTOCOL);
```

R_QSPIX_Get_Status()

Get status of Prefetch, busy flag, ROM access error flag.

Format

```
qspix_err_t R_QSPIX_Get_Status(qspix_cmd_t cmd, uint8_t *return_status);
```

Parameters

cmd

Command to get status

**return_status*

Pointer store status corresponding with command

Return Values

QSPIX_SUCCESS /* Processing completed without problem */

QSPIX_ERR_INVALID_COMMAND /* Arguments are invalid */

Properties

Prototyped in file "r_qspix_rx_if.h"

Description

This function return status corresponding with input cmd.

```
typedef enum e_qspix_cmd
{
    QSPIX_GET_PREFETCH_BUFFER_FILL_LEVEL, /* Get Prefetch Buffer Fill Level */
    QSPIX_GET_PREFETCH_BUFFER_FULL_FLAG, /* Get Prefetch Buffer Full Flag */
    QSPIX_GET_PREFETCH_FUNCTION_OPERATING_STATUS_FLAG, /* Get Prefetch Function
                                                         Operating Status Flag */
    QSPIX_GET_BUS_BUSY_FLAG, /* Get Bus Busy Flag */
    QSPIX_GET_ROM_ACCESS_ERROR_FLAG, /* Get ROM Access Error Flag */
    QSPIX_GET_XIP_STATUS_FLAG /* Get XIP Status Flag */
} qspix_cmd_t;
```

Example

```
/* Conditions: Channel currently open. */
/* Variable store to status */
uint8_t status;

/* Get prefetch buffer fill level and store to variable status*/
R_QSPIX_Get_Status(QSPIX_GET_PREFETCH_BUFFER_FILL_LEVEL, &status);
```

R_QSPIX_Close()

Close the QSPIX driver module.

Format

```
qspi_err_t R_QSPIX_Close(uint8_t channel);
```

Parameters

channel

Channel of QSPIX need to close.

Return Values

```
QSPIX_SUCCESS      /* Successful; channel initialized */
QSPIX_ERR_NOT_OPEN /* QSPIX module is not initialized yet */
QSPIX_ERR_INVALID_ARG /* Invalid argument */
```

Properties

The declaration is located in `r_qspi_rx_if.h`.

Description

Disables the QSPIX channel and enters module-stop state. The QSPIX channel cannot be used again until it has been reopened with the `R_QSPIX_Open` function. If this function is called for an QSPIX that is not in the open state then an error code is returned.

Example

```
/* Conditions: Channel currently open. */

qspi_err_t ret;
ret = R_QSPIX_Close(QSPIX_CH0);
if (QSPIX_SUCCESS != result)
{
    return result;
}
```

R_QSPIX_GetVersion()

This function returns the version number of the API.

Format

```
uint32_t R_QSPIX_GetVersion(void);
```

Parameters

None

Return Values

Version Number

Properties

The declaration is located in `r_qspix_rx_if.h`.

Description

The function returns the version of this module. The version number is encoded such that the top two bytes are the major version number and the bottom two bytes are the minor version number.

Example

```
/* Retrieve the version number and convert it to a string. */
uint32_t version, version_high, version_low;
char version_str[9];

version = R_QSPIX_GetVersion();
version_high = (version >> 16)&0xf;
version_low = version & 0xff;

sprintf(version_str, "QSPIXv%1.1hu.%2.2hu", version_high, version_low);
```

4. Pin Setting

To use the QSPIX FIT module, assign input/output signals of the peripheral function to pins with the multi-function pin controller (MPC). The pin assignment is referred to as the "Pin Setting" in this document.

Please perform the pin setting after calling the R_QSPIX_Open function.

When performing the pin setting in the e² studio, the Pin Setting feature of the FIT Configurator or the Smart Configurator can be used. When using the Pin Setting feature, a source file is generated according to the option selected in the Pin Setting window in the FIT Configurator or the Smart Configurator. Then pins are configured by calling the function defined in the source file. Refer to Table 4.1 Function Output by the FIT Configurator

Table 4.1 Function Output by the FIT Configurator

MCU Used	Function to be Output	Remarks
All MCUs	R_QSPIX_PinSet_QSPIXx	x: Channel number

5. Demo Projects

Demo projects include function `main()` that utilizes the FIT module and its dependent modules (e.g. `r_bsp`). This FIT module includes the following demo projects.

5.1 `qspix_demo_rskrx671`, `qspix_demo_rskrx671_gcc`

The sample demo uses Indirect Access Mode of the QSPIX function to write the program to the external flash memory on the RSKRX671 starter kit.

After QSPIX transits to XIP mode, it then executes the function on the external flash memory.

Functions on the external flash memory turn on and turn off LED0 to LED1 sequentially.

5.2 Adding a Demo to a Workspace

Demo projects are found in the FITDemos subdirectory of the distribution file for this application note. To add a demo project to a workspace, select *File >> Import >> General >> Existing Projects into Workspace*, then click "Next". From the Import Projects dialog, choose the "Select archive file" radio button. "Browse" to the FITDemos subdirectory, select the desired demo zip file, then click "Finish".

5.3 Downloading Demo Projects

Demo projects are not included in the RX Driver Package. When using the demo project, the FIT module needs to be downloaded. To download the FIT module, right click on this application note and select "Sample Code (download)" from the context menu in the *Smart Browser >> Application Notes* tab.

6. Appendices

6.1 Operation Confirmation Environment

This section describes for detailed the operating test environments of this module.

Table 6-1 Confirmed Operation Environment (Rev.1.30)

Item	Contents
Integrated development environment	Renesas Electronics e2 studio Version 2022-07 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.04.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99 GCC for Renesas RX 8.3.0.202202 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.1.30
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)

Table 6-2 Confirmed Operation Environment (Rev.1.20)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 2021-10 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99 GCC for Renesas RX 8.3.0.202102 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.1.20
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)

Table 6-3 Confirmed Operation Environment (Rev.1.10)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 2021-07 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99 GCC for Renesas RX 8.3.0.202004 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.1.10
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)

Table 6-4 Confirmed Operation Environment (Rev.1.00)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 2021-07 IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99 GCC for Renesas RX 8.3.0.202004 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99 Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used: -Wl,--no-gc-sections This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.1.00
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)

6.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

- Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

- Using e² studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using this FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

(2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r_qspix_rx module.

A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.

(3) Q: I have added the FIT module to the project and built it. Then I got an error for when the configuration setting is wrong.

A: The setting in the file "r_qspix_rx_config.h" may be wrong. Check the file "r_qspix_rx_config.h". If there is a wrong setting, set the correct value for that. Refer to 2.8 Configuration Overview for details.

7. Reference Documents

User's Manual: Hardware

Technical Update/Technical News

User's Manual: Development Tools

The latest version can be downloaded from the Renesas Electronics website.

Related Technical Update

Not applicable technical update for this module.

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Mar 31, 2021	--	First edition issued
1.10	Sep 20, 2021	18, 19	Updated Special Notes for R_QSPIX_Write_Indirect() and R_QSPIX_Read_Indirect().
		28	Updated section 5. Demo Projects.
		29	6.1 Confirmed Operation Environment: Added Table for Rev.1.10.
		Program	Fixed R_QSPIX_Write_Indirect()
1.20	Dec 07, 2021	29	6.1 Confirmed Operation Environment: Added Table for Rev.1.20.
		Program	Supports multiple consecutive calls to R_QSPIX_Write_Indirect(). Updated demo projects.
1.30	Jul 29, 2022	29	6.1 Confirmed Operation Environment: Added Table for Rev.1.30.
		Program	Updated demo projects.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems.

The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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